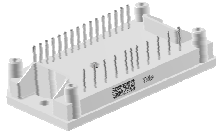
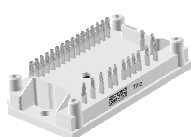
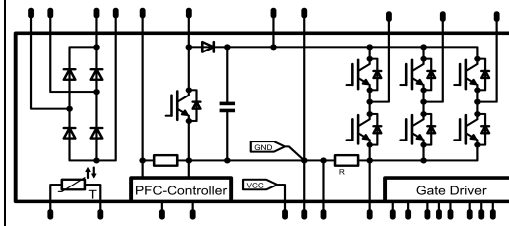




<i>flow</i> IPM 1B	600 V / 4 A
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Features</b></div> <ul style="list-style-type: none"> <li>Input Rectifier, PFC-Boost with integrated PFC-Shunt, PFC-Controller and DC-capacitor</li> <li>3 phase inverter with integrated DC Shunt, gate driver circuit incl. bootstrap circuit and over current protection</li> <li>Sense output of DC-current</li> <li>Temperature sensor</li> <li>Conclusive Power Flow, all power connections on one side, no input output X-ing</li> </ul>	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>flow 1B housing</b></div> <div style="display: flex; justify-content: space-around; align-items: center;">   </div> <p style="display: flex; justify-content: space-around; font-size: small;"> <span>solder pins</span> <span>Press-fit pins</span> </p>
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Target Applications</b></div> <ul style="list-style-type: none"> <li>Low Power Industrial Drives</li> <li>Motor Integrated Fans and Pumps</li> <li>AirCon</li> <li>Electrical Tools</li> </ul>	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Schematic</b></div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Types</b></div> <ul style="list-style-type: none"> <li>20-1B06IPB004RC-P952A40</li> <li>20-PB06IPB004RC-P952A40Y</li> </ul>	

## Maximum Ratings

$T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	13	A
Surge (non-repetitive) forward current	$I_{FSM}$	$t_p = 10\text{ ms}$ 50 Hz half sine wave	130	A
$I^2t$ -value	$I^2t$	$T_j = 45\text{ }^\circ\text{C}$	80	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	15	W
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$
<b>PFC IGBT</b>				
Collector-emitter breakdown voltage	$V_{CE}$		650	V
DC collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	8	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	45	A
Turn off safe operating area		$V_{CE} \leq 650\text{V}$ , $T_j \leq T_{op\text{ max}}$	45	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ }^\circ\text{C}$	16	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$



## Maximum Ratings

 $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### PFC Inverse Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		650	V
DC forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	6	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	12	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	10	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### PFC Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		650	V
DC forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	9	A
Surge (non-repetitive) forward current	$I_{FSM}$	$t_p = 8,3\text{ms}$	100	A
$I^2t$ -value	$I^2t$	60 Hz half sine wave	40	A <sup>2</sup> s
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	30	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	15	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Inverter Transistor

Collector-emitter breakdown voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	4	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	12	A
Turn off safe operating area		$V_{CE} \leq 600\text{V}$ , $T_j \leq T_{jmax}$	8	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	12	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150\text{ °C}$ $V_{GE} = 15\text{ V}$	8 400	µs V
Maximum Junction Temperature	$T_{jmax}$		175	°C



## Maximum Ratings

 $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Inverter Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	5	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	8	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	9	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### PFC Shunt

DC forward current	$I_F$	$T_c = 25\text{ °C}$	10	A
Power dissipation	$P_{tot}$	$T_c = 25\text{ °C}$	9	W

### PFC Controller\*

VCC supply voltage	$V_{CC}$	$V_{CC}$ common with gate driver $I_c$	26	V
VSENSE voltage	$V_{VSENSE}$		26	V
Vsense Current	$I_{VSENSE}$		800	μA
FREQ pin voltage	$V_{FREQ}$		5,3	V
Maximum Junction Temperature	$T_{jmax}$		125	°C

\* for more information see Infineon's datasheet ICE3PCS02

### DC - Shunt

DC forward current	$I_F$	$T_c = 25\text{ °C}$	8	A
Power dissipation	$P_{tot}$	$T_c = 25\text{ °C}$	3,2	W

### DC link Capacitor

Max.DC voltage	$V_{MAX}$	$T_c = 25\text{ °C}$	500	V
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### Gate Driver\*

Supply voltage	$V_{CC}$	$V_{CC}$ common with PFC driver	20	V
Input voltage (LIN, HIN, EN)	$U_{IN}$		10	V
Output voltage (FAULT)	$U_{OUT}$		$V_{CC} + 0.5$	V

\* for more information see infineon's datasheet 6ED003L02-F2



## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{is}$	$t = 2\text{ s}$ DC Test Voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	



### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Input Rectifier Diode

Parameter	Symbol	Conditions	Value	Unit
Forward voltage *	$V_F$	$V_{GE}$ [V] $V_{GS}$ [V]	7 25 125	V
Threshold voltage (for power loss calc. only)	$V_{th}$		25 125	V
Slope resistance (for power loss calc. only)	$r_t$		25 125	mΩ
Reverse current	$I_r$	1600	25 125	mA
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$	4,56	K/W

\* chip data

#### PFC IGBT

Parameter	Symbol	Conditions	Value	Unit		
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$	0,0004 25	V		
Collector-emitter saturation voltage*	$V_{CE(sat)}$	15	6 25 150	V		
Collector-emitter cut-off	$I_{CES}$	0 650	25	mA		
Rise time	$t_r$	$U_{CC} = 15V$ 400	25 150	ns		
Turn-off delay time **	$t_{d(off)}$		25 150			
Fall time	$t_f$		25 150			
Turn-on energy loss	$E_{on}$		25 150		mWs	
Turn-off energy loss	$E_{off}$	25 150				
Input capacitance	$C_{ies}$	$f = 1\text{ MHz}$ 0	25	25	930	pF
Output capacitance	$C_{oss}$				24	
Reverse transfer capacitance	$C_{rss}$				4	
Gate charge	$Q_G$	$\pm 15$ 520	15 25	38	nC	
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$	5,80	K/W		

\* chip data

#### PFC Inverse Diode

Parameter	Symbol	Conditions	Value	Unit
Diode forward voltage	$V_F$		6 25 125	V
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$	9,56	K/W

#### PFC Diode

Parameter	Symbol	Conditions	Value	Unit	
Forward voltage *	$V_F$		6 25 150	V	
Peak recovery current	$I_{RRM}$	$U_{CC}=15V$ 400	25 150	A	
Reverse recovery time	$t_{rr}$		25 150		
Reverse recovery charge	$Q_{rr}$		25 150		μC
Reverse recovered energy	$E_{rec}$		25 150		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25 150	A/μs	
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$	7,19	K/W	

\* chip data

#### PFC Shunt

Parameter	Symbol	Value	Unit
R1 value	$R$	100	mΩ



### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Inverter Transistor

Parameter	Symbol	Conditions	$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,000075	25	4,4	5	5,6	V
Collector-emitter saturation voltage*	$V_{CE(sat)}$		15		4	25 150	1,7	2,20 2,29	2,8	v
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600		25			0,1	mA
Gate-emitter leakage current	$I_{GES}$		20	0		25			120	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time **	$t_{d(on)}$	$U_{ce}=15V$ $V_{in}=5V$	400	4	4	25		586		ns
Rise time	$t_r$					150		635		
Turn-off delay time **	$t_{d(off)}$					25		21		
Fall time	$t_f$					150		30		
Turn-on energy loss	$E_{on}$					25		666		
Turn-off energy loss	$E_{off}$					150		749		
Input capacitance	$C_{ies}$	$f = 1 \text{ MHz}$	0	25	25			305		pF
Output capacitance	$C_{oss}$							18		
Reverse transfer capacitance	$C_{rss}$							9		
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$						8,93		K/W

\* chip data  
 \*\* including gate driver

#### Inverter Diode

Parameter	Symbol	Conditions	$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
Diode forward voltage *	$V_F$				4	25 150	1,5	2,08 1,92	2,6	V
Peak reverse recovery current	$I_{RRM}$	$U_{ce}=15V$ $V_{in}=5V$	400	4	4	25		2		A
Reverse recovery time	$t_{rr}$					150		3		
Reverse recovered charge	$Q_{rr}$					25		166		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		254		
Reverse recovered energy	$E_{rec}$					25		0,18		
Thermal resistance junction to sink	$R_{th(j-s)}$					150		0,35		
Thermal resistance junction to sink	$R_{th(j-s)}$	phase-change material $\lambda = 3,4W/mK$						10,05		K/W

\* chip data

#### DC - Shunt

Parameter	Symbol	Conditions	$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
R2 value	$R$					25		50		m $\Omega$

#### DC link Capacitor

Parameter	Symbol	Conditions	$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	Unit
C value	$C$							100		nF



**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max		
		$V_{GS}$ [V]	$V_{CE}$ [V]	$I_F$ [A]						
			$V_{DS}$ [V]	$I_D$ [A]						
<b>Gate Driver</b>										
Supply voltage	$V_{CC}$					25 125	13	15	17,5	V
Quiescent Vcc supply current	IQCC	VLIN=0V; VHIN=3,3V				25 125		1,3	2	mA
Input voltage (LIN, HIN, EN)	VIN	$V_{CC} = 15V$				25 125	0		5	V
Input voltage (GATE)	VGATE		25 125	0		15				
Logic "0" input voltage (LIN, HIN)	VIH		25 125	1,7	2,1	2,4				
Logic "1" input voltage (LIN, HIN)	VIL		25 125	0,7	0,9	1,1				
Positive going threshold voltage (EN)	VEN, TH+		25 125	1,9	2,1	2,3				
Negative going threshold voltage (EN)	VEN, TH-		25 125	1,1	1,3	1,5				
Input clamp voltage (LIN, HIN, EN)	VIN, CLAMP		IIN = 4mA	25 125	9	10,3	12			
ITRIP positive going threshold	VIT, TH+		25 125	380	445	510	mV			
Input bias current LIN high	$I_{iIN+}$	VLIN = 3,3V	25 125		70	100	$\mu A$			
Input bias current LIN low	$I_{iIN-}$	VLIN = 0V	25 125		110	200				
Input bias current HIN high	$I_{iHIN+}$	VHIN = 3,3V	25 125		70	100				
Input bias current HIN low	$I_{iHIN-}$	VHIN = 0V	25 125		110	200				
Input bias current EN high	IEN+	VHIN = 3,3V	25 125		45	120				
Output voltage (FAULT)	$V_{FLT}$		25 125	0		$V_{CC}$		V		
Low on resistor of pull down trans. (FAULT)	RON, FLT	$V_{rFAULT} = 0.5 V$	25 125		45	100	$\Omega$			
Pulse width for ON or OFF	tIN		25 125	1			$\mu s$			
Turn-on propagation delay (LIN, HIN)	tON	VLIN/HIN = 0V or 3,3V	25 125	400	530	800	ns			
Turn-off propagation delay (LIN, HIN)	tOFF	VLIN/HIN = 0V or 3,3V	25 125	360	490	760				
FAULT reset time	tRST		25 125		4		ms			
Fixed deadtime between high and low side	tDT	VLIN/HIN = 0V & 3,3V	25 125	150	310		ns			



### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Thermistor

Parameter	Symbol	Conditions	Value	Unit
Rated resistance	R		25	$\Omega$
Deviation of $R_{100}$	$\Delta R/R$		100	%
Power dissipation	P		25	mW
Power dissipation constant			25	mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$	25	K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$	25	K
Vincotech NTC Reference			25	B

#### PFC Controller

Parameter	Symbol	Conditions	Value	Unit
Supply voltage*	$V_{CC}$		15	V
VCC turn-on threshold	$V_{CCon}$		11,5	V
VCC turn-off threshold	$V_{CCUvLO}$		10,5	V
Operating current with active GATE	$I_{CCHG}$	$C_L = 1nF$	6,4	mA
Operating current during standby	$I_{CCstby}$		3,5	mA
PFC switching frequency	$F_{SWnom}$	Set with an internal resistor $R_{FREQ} = 220k\Omega^{**}$	20	kHz
PFC disable threshold	$V_{dis PFC}$	pull Vsense higher than $V_{dis PFC}$ to disable PFC operation	14	V
DC link voltage	DC2+	Set with an internal resistor divider***	325	V
DC link threshold (OVP1) low to high	$V_{OVP1L2H}$	relative to output voltage OVP1 values varies with external resistor Feedback voltage $V_{Dclink}/130$ can be measured at VSENSE pin	108	%
DC link threshold (OVP1) high to low	$V_{OVP1H2L}$		100	%
Blanking time for OVP1	$t_{OVP1}$		12	$\mu s$
DC link threshold (OVP1) hysteresis	$V_{OVP1\_HYS}$		6	%
DC link threshold (OVP2) low to high	$V_{OVP2\_L2H}$	relative to OVP2	428	V
DC link threshold (OVP2) high to low	$V_{OVP2\_H2L}$		92	%
Blanking time for OVP2	$t_{OVP2}$		12	$\mu s$

\*recommended supply voltage range: 15-18 V

\*\*switching frequency is settable by an external resistor between pins 14-16 (see figure on page30 for values)

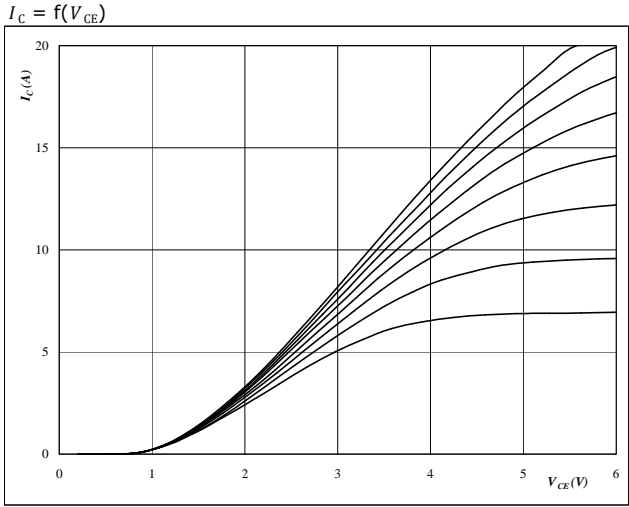
\*\*\*DC link voltage is settable by an external resistor between pins 14-15 (see figure on page30 for values)





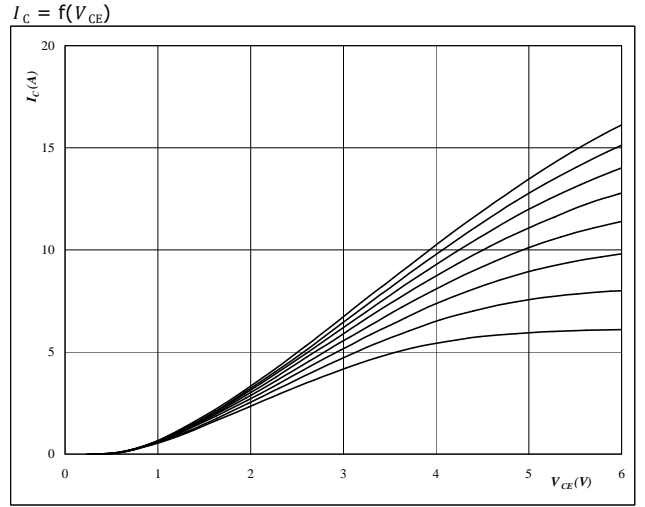
### Output Inverter

**figure 1.** IGBT  
**Typical output characteristics**



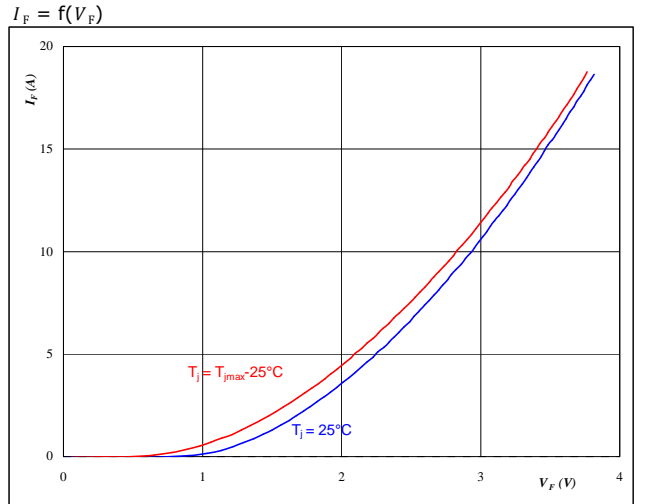
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $U_{CC}$  from 10 V to 17V in steps of 1V

**figure 2.** IGBT  
**Typical output characteristics**



**At**  
 $t_p = 250 \mu s$   
 $T_j = 125 \text{ } ^\circ C$   
 $U_{CC}$  from 10 V to 17V in steps of 1V

**figure 3.** FWD  
**Typical diode forward current as a function of forward voltage**



**At**  
 $t_p = 250 \mu s$

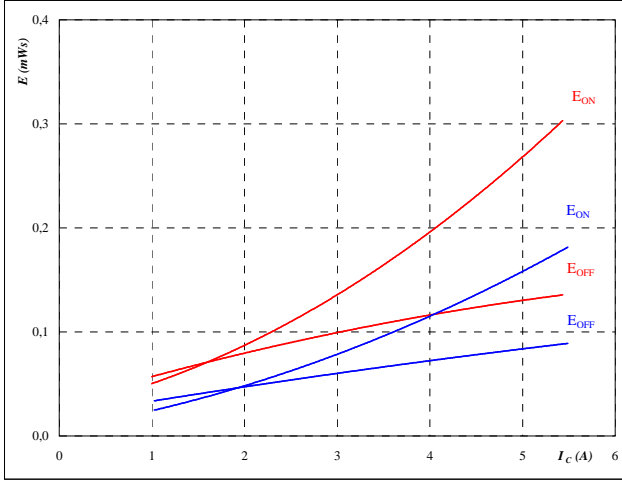


### Output Inverter

**figure 4.** IGBT

**Typical switching energy losses  
as a function of collector current**

$E = f(I_C)$



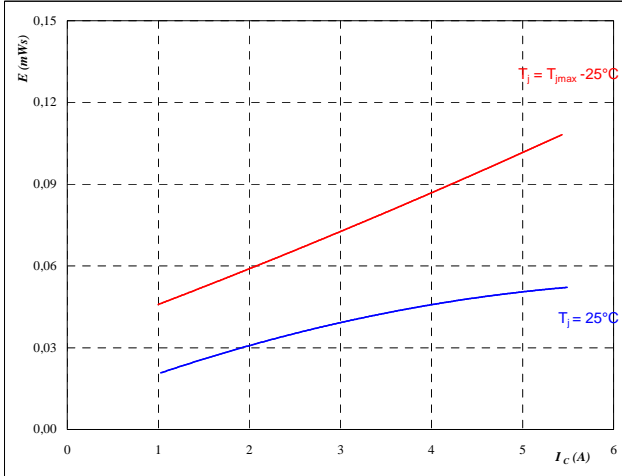
With an inductive load at

- $T_j = 25/125 \text{ } ^\circ\text{C}$
- $V_{CE} = 400 \text{ V}$
- $U_{CC} = 15 \text{ V}$

**figure 5.** FWD

**Typical reverse recovery energy loss  
as a function of collector current**

$E_{rec} = f(I_C)$



With an inductive load at

- $T_j = 25/125 \text{ } ^\circ\text{C}$
- $V_{CE} = 400 \text{ V}$
- $U_{CC} = 15 \text{ V}$

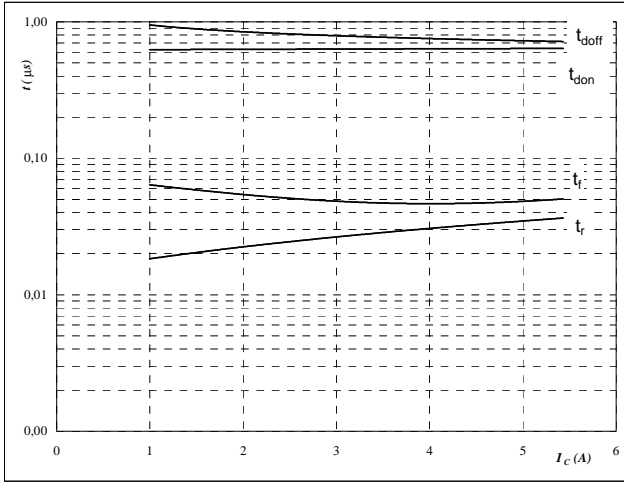


### Output Inverter

**figure 6.** IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



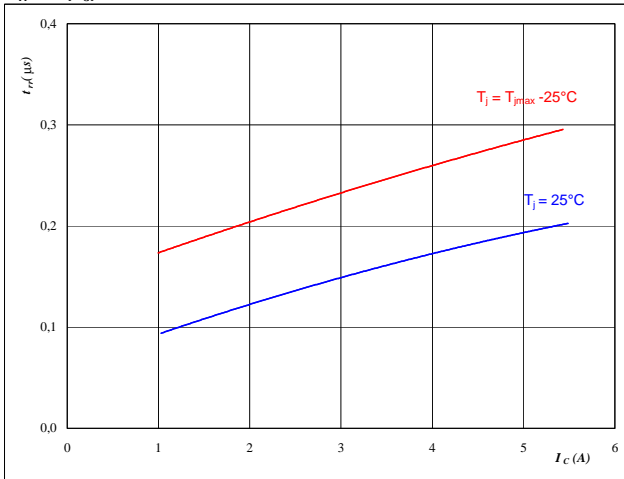
With an inductive load at

$T_j = 125 \text{ } ^\circ\text{C}$   
 $V_{CE} = 400 \text{ V}$   
 $U_{CC} = 15 \text{ V}$

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



At

$T_j = 25/125 \text{ } ^\circ\text{C}$   
 $V_{CE} = 400 \text{ V}$   
 $U_{CC} = 15 \text{ V}$

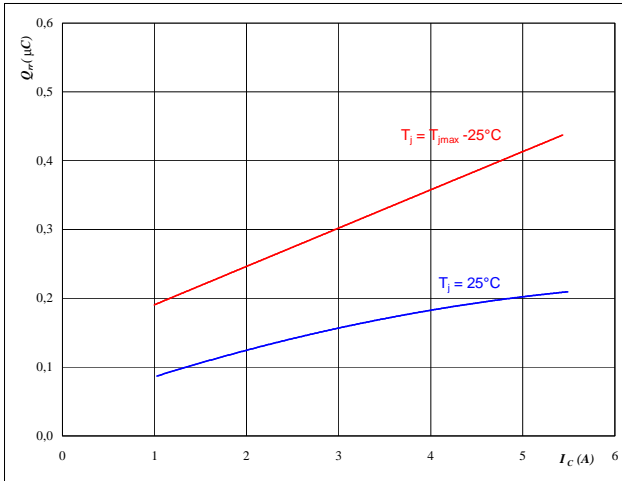


### Output Inverter

**figure 8.** FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

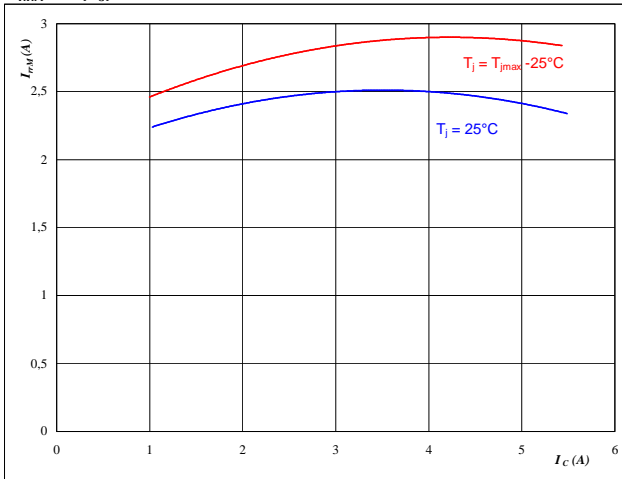


**At**  
 $T_j = 25/125$  °C  
 $V_{CE} = 400$  V  
 $U_{CC} = 15$  V

**figure 9.** FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$



**At**  
 $T_j = 25/125$  °C  
 $V_{CE} = 400$  V  
 $U_{CC} = 15$  V

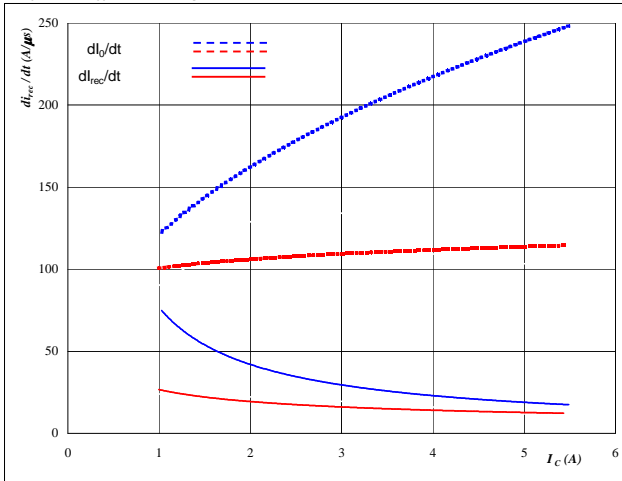


### Output Inverter

**figure 10.** FWD

**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_C)$$

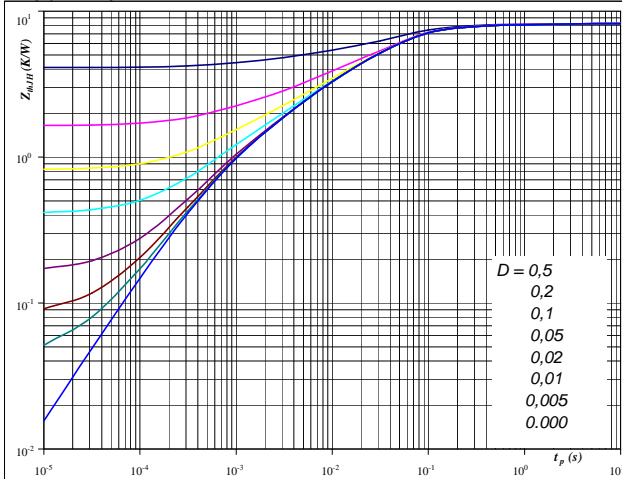


**At**  
 $T_j = 25/125$  °C  
 $V_{CE} = 400$  V  
 $U_{CC} = 15$  V

**figure 11.** IGBT

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 8,20$  K/W

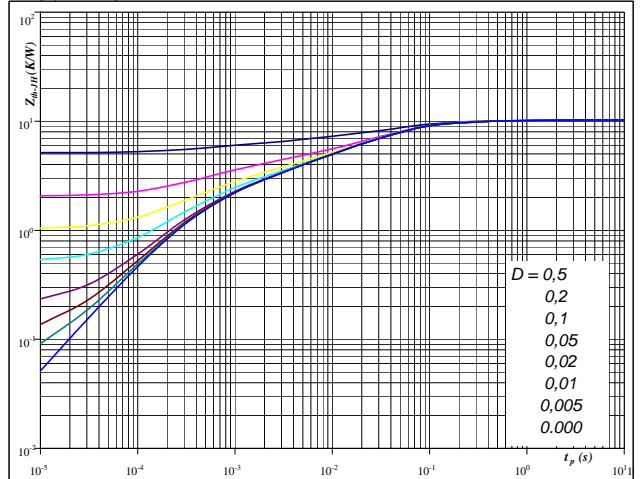
IGBT thermal model values

R (K/W)	Tau (s)
2,49E-01	1,64E+00
9,97E-01	1,59E-01
4,55E+00	3,81E-02
1,65E+00	5,10E-03
6,64E-01	7,96E-04
9,00E-02	3,11E-04

**figure 12.** FWD

**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 10,24$  K/W

FWD thermal model values

R (K/W)	Tau (s)
5,43E-01	6,92E-01
3,81E+00	5,93E-02
2,56E+00	1,81E-02
1,83E+00	2,58E-03
1,50E+00	3,50E-04

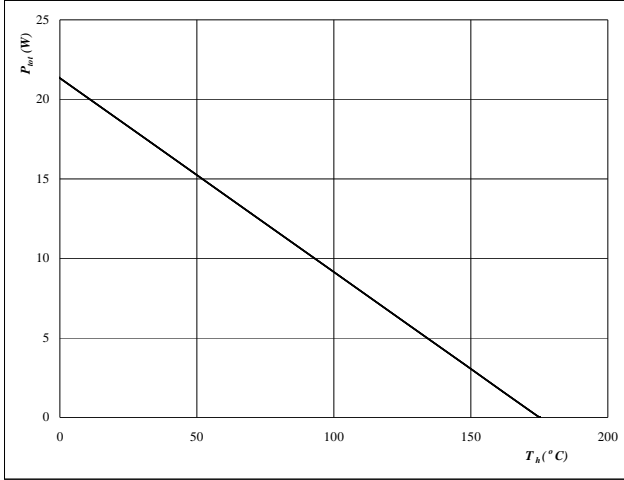


### Output Inverter

**figure 13.** IGBT

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_s)$

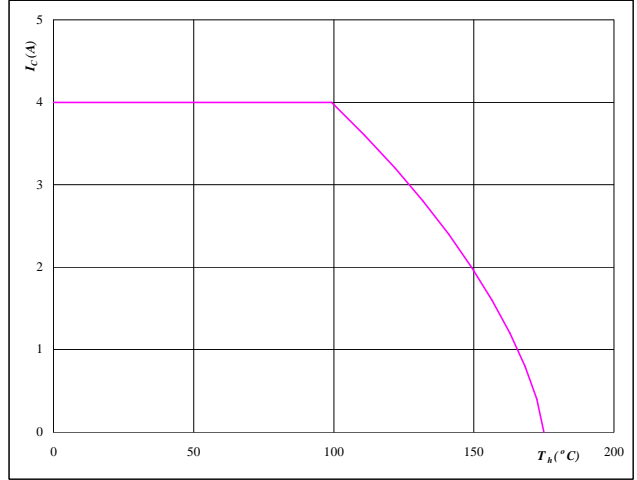


**At**  
T<sub>j</sub> = 175 °C

**figure 14.** IGBT

**Collector current as a function of heatsink temperature**

$I_C = f(T_s)$

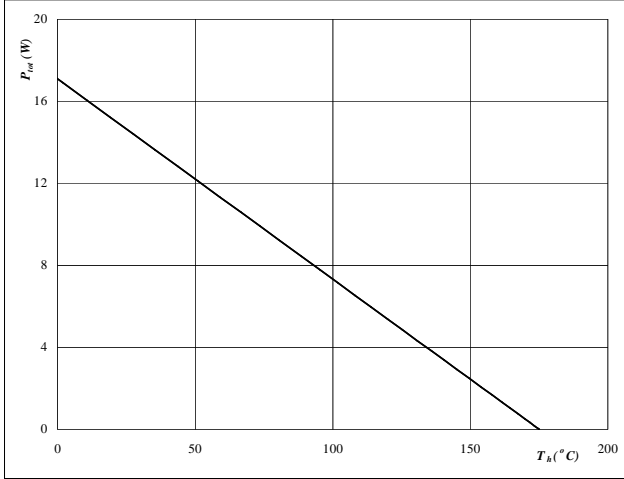


**At**  
T<sub>j</sub> = 175 °C  
U<sub>CC</sub> = 15 V

**figure 15.** FWD

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_s)$

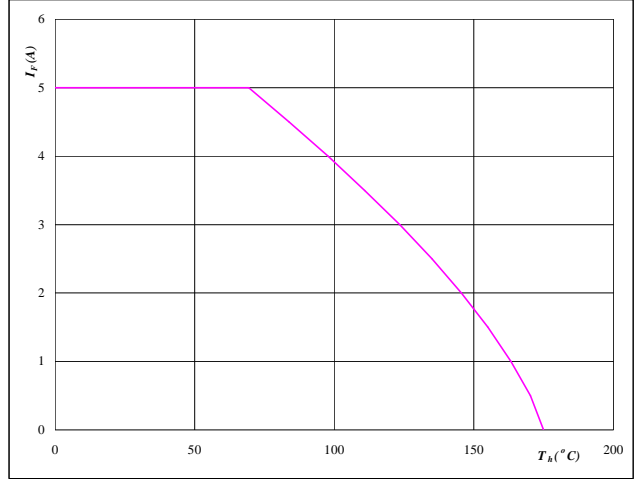


**At**  
T<sub>j</sub> = 175 °C

**figure 16.** FWD

**Forward current as a function of heatsink temperature**

$I_F = f(T_s)$



**At**  
T<sub>j</sub> = 175 °C

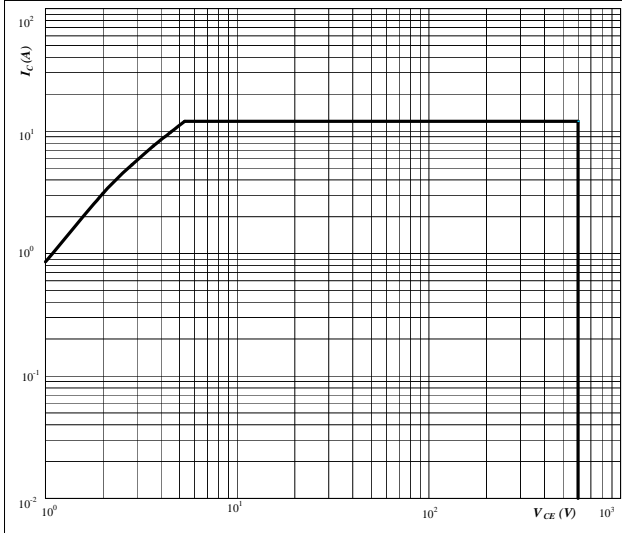


### Output Inverter

**figure 17.** IGBT

Safe operating area as a function of collector-emitter voltage

$I_C = f(V_{CE})$

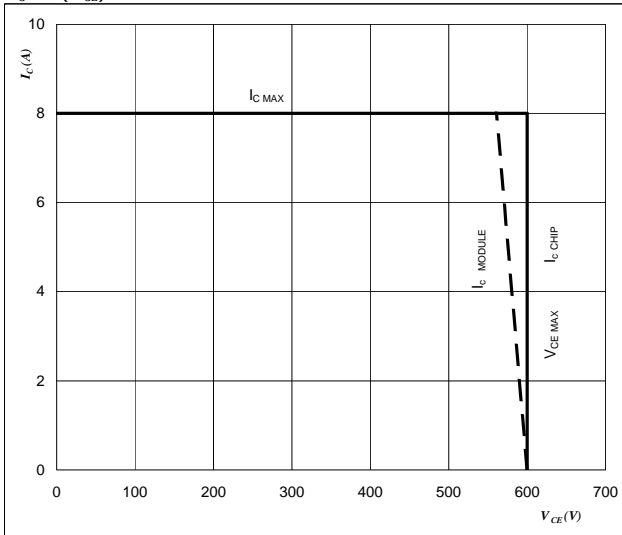


**At**  
 $T_j \leq T_{jmax}$  °C  
 $U_{CC} = 15$  V

**figure 18.** IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$

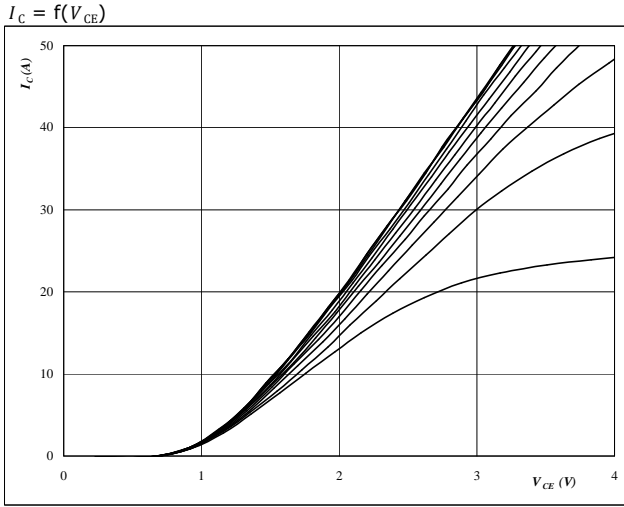


**At**  
 $T_j = T_{jmax} - 25$  °C



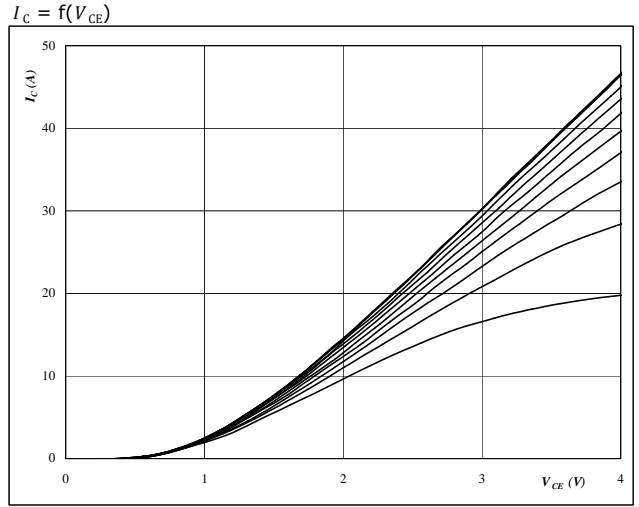
### PFC

**figure 1.** IGBT  
**Typical output characteristics**



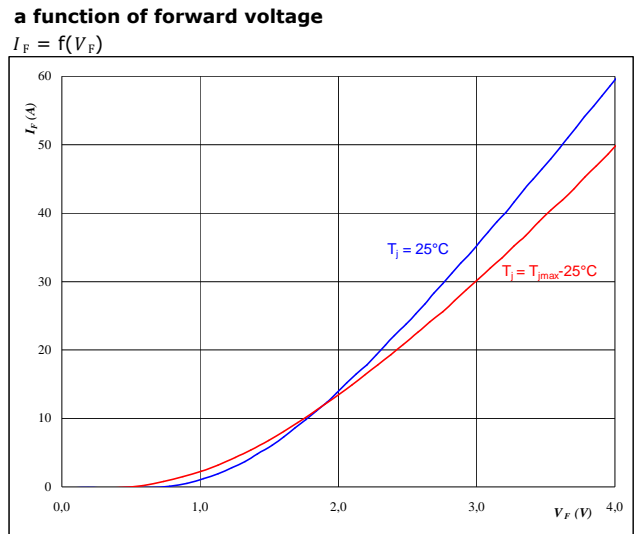
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $U_{CC}$  from 7 V to 17V in steps of 1V

**figure 2.** IGBT  
**Typical output characteristics**



**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $U_{CC}$  from 7 V to 17V in steps of 1V

**figure 3.** FWD  
**Typical diode forward current as a function of forward voltage**



**At**  
 $t_p = 250 \mu s$



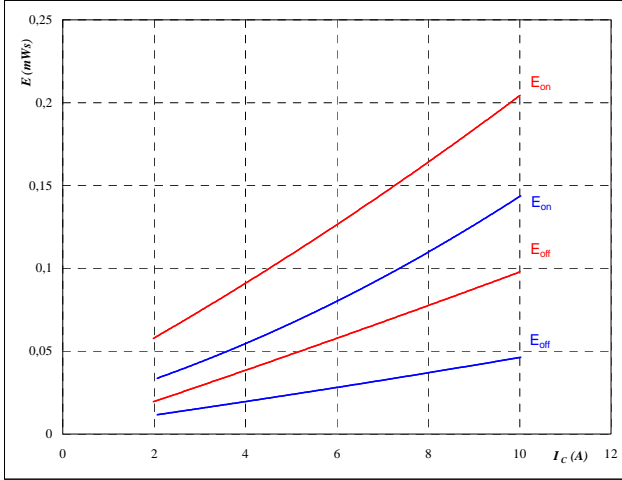


PFC

figure 4. IGBT

Typical switching energy losses  
as a function of collector current

$E = f(I_c)$



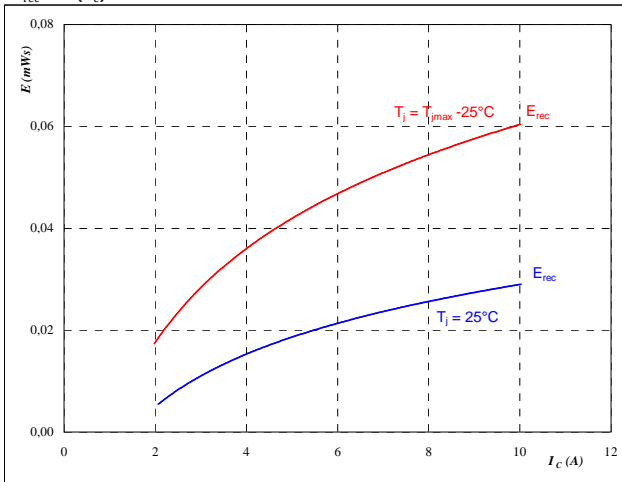
With an inductive load at

- $T_j = 25/125$  °C
- $V_{CE} = 400$  V
- $U_{CC} = 15$  V

figure 5. IGBT

Typical reverse recovery energy loss  
as a function of collector current

$E_{rec} = f(I_c)$



With an inductive load at

- $T_j = 25/125$  °C
- $V_{CE} = 400$  V
- $U_{CC} = 15$  V

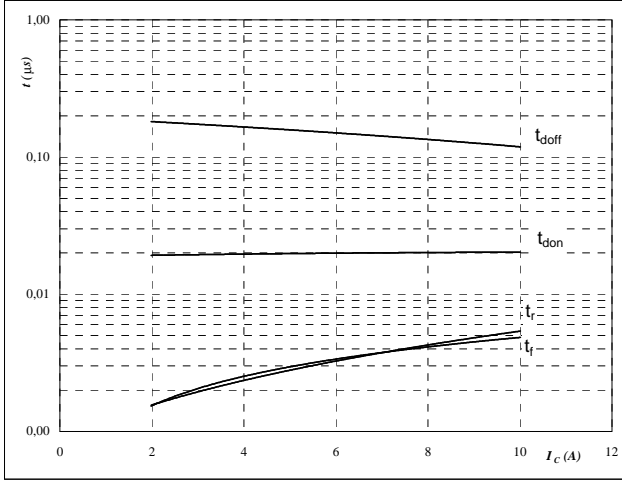


PFC

figure 6. IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



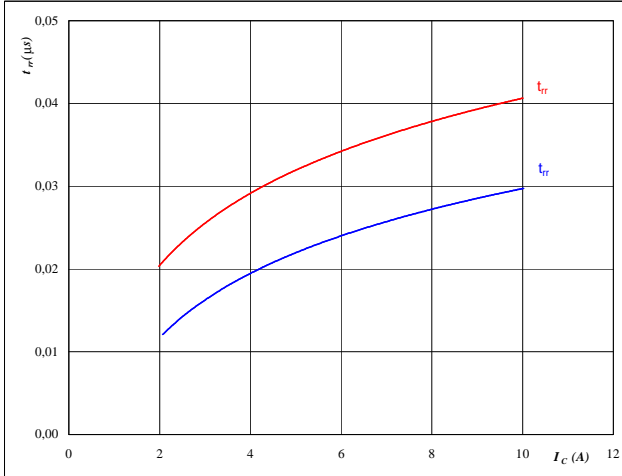
With an inductive load at

- $T_j = 125$  °C
- $V_{CE} = 400$  V
- $U_{CC} = 15$  V

figure 7. FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



At

- $T_j = 25/125$  °C
- $V_{CE} = 400$  V
- $U_{CC} = 15$  V

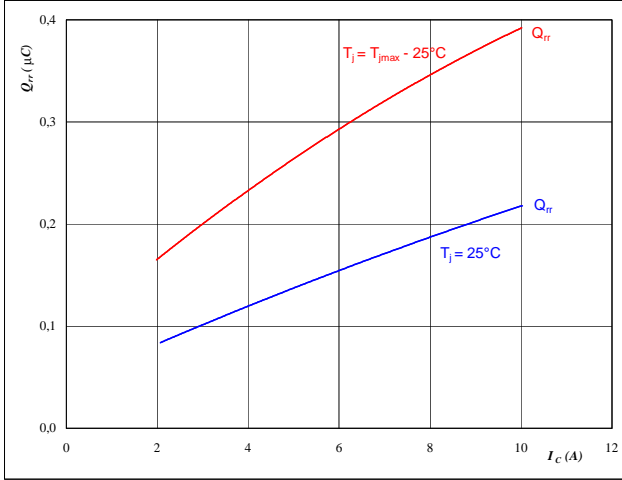


PFC

figure 8. FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_C)$



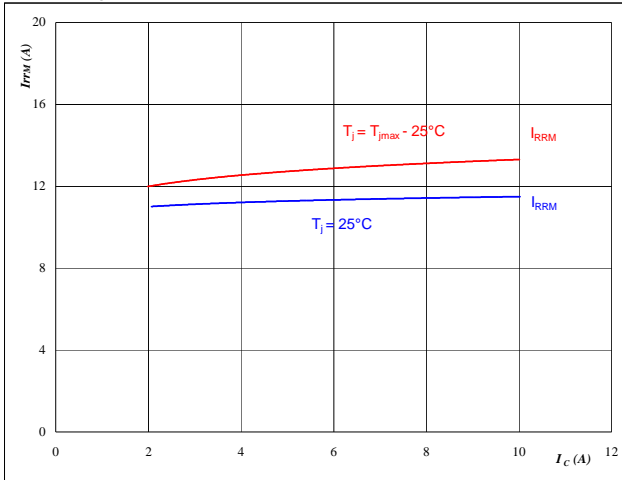
At

$T_j =$	25/125	°C
$V_{CE} =$	400	V
$U_{CC} =$	15	V

figure 9. FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_C)$



At

$T_j =$	25/125	°C
$V_{CE} =$	400	V
$U_{CC} =$	15	V

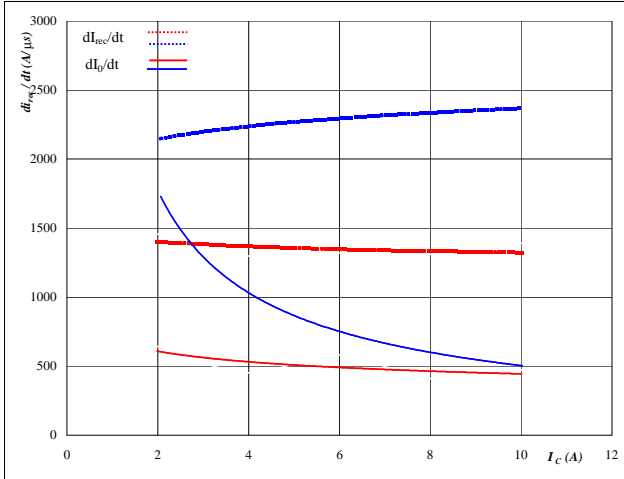


PFC

**figure 10.** FWD

**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$dI_0/dt, dI_{rec}/dt = f(I_c)$

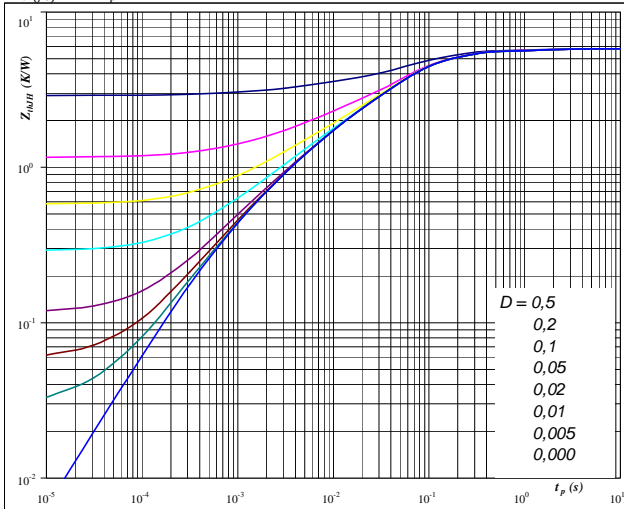


**At**  
 $T_j = 25/125$  °C  
 $V_{CE} = 400$  V  
 $U_{CC} = 15$  V

**figure 11.** IGBT

**IGBT transient thermal impedance as a function of pulse width**

$Z_{th(j-s)} = f(t_p)$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 5,80$  K/W

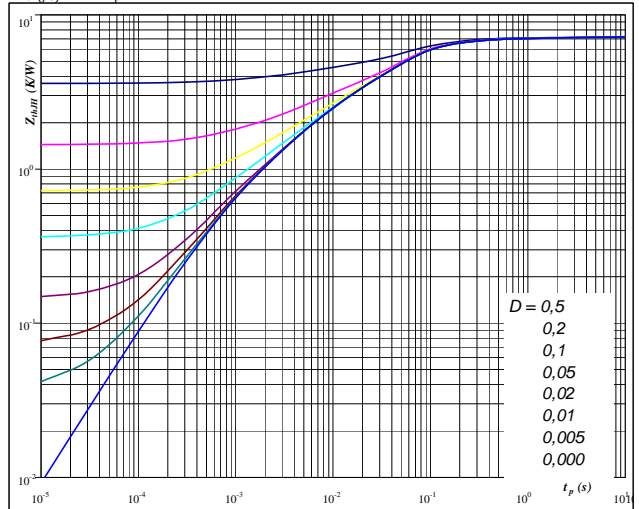
IGBT thermal model values

R (C/W)	Tau (s)
8,85E-02	4,38E+00
3,12E-01	8,32E-01
1,99E+00	1,12E-01
2,31E+00	3,80E-02
8,99E-01	4,25E-03
	5,94E-04

**figure 12.** FWD

**FWD transient thermal impedance as a function of pulse width**

$Z_{th(j-s)} = f(t_p)$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 7,19$  K/W

FWD thermal model values

R (C/W)	Tau (s)
2,22E-01	2,69E+00
6,61E-01	2,71E-01
4,47E+00	4,89E-02
1,43E+00	5,11E-03
4,13E-01	7,51E-04

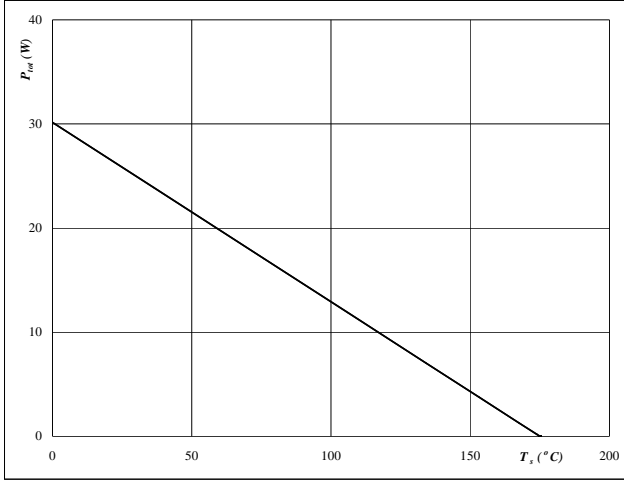


### PFC

**figure 13.** IGBT

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

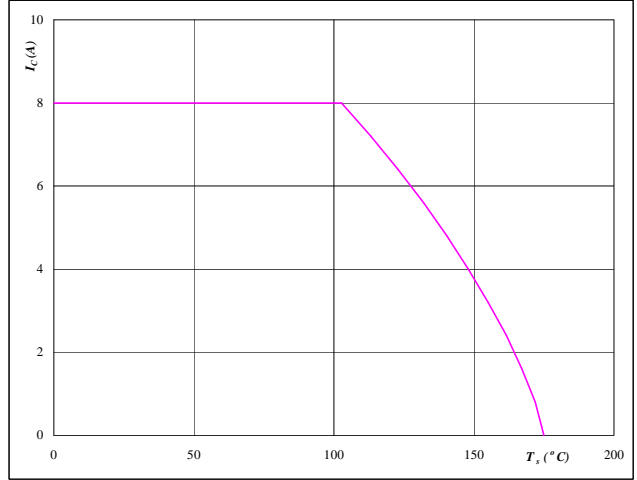


**At**  
T<sub>j</sub> = 175 °C

**figure 14.** IGBT

**Collector current as a function of heatsink temperature**

$$I_C = f(T_s)$$

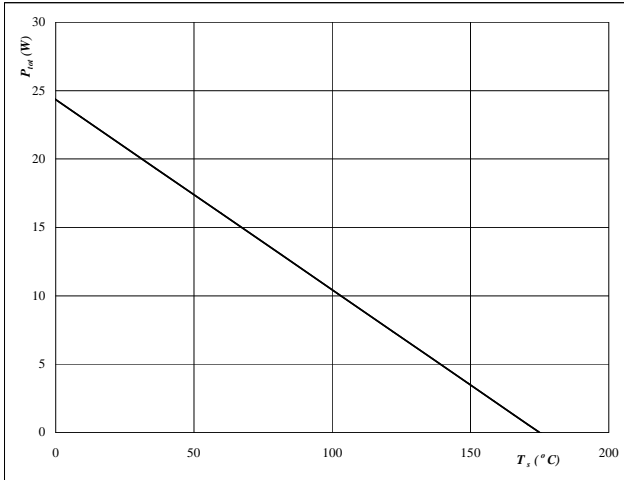


**At**  
T<sub>j</sub> = 175 °C  
U<sub>CC</sub> = 15 V

**figure 15.** FWD

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

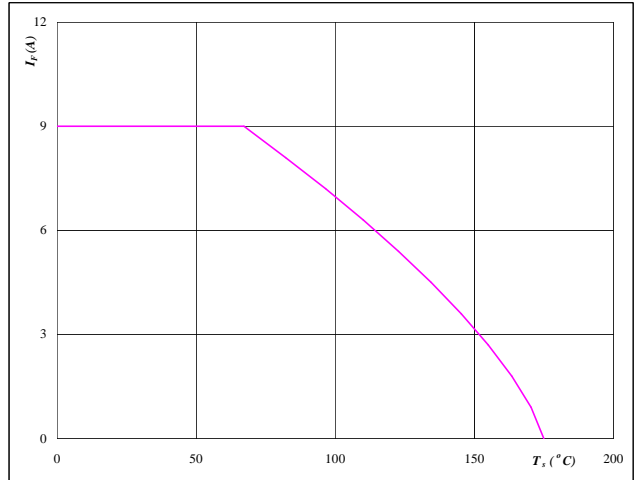


**At**  
T<sub>j</sub> = 175 °C

**figure 16.** FWD

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$



**At**  
T<sub>j</sub> = 175 °C

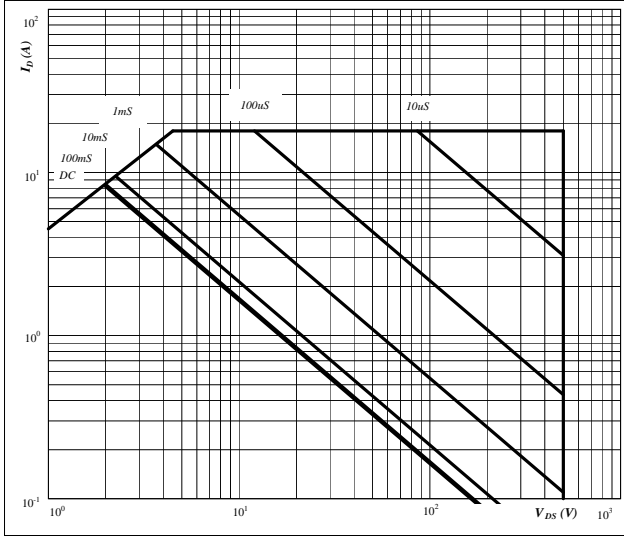


PFC

figure 17. IGBT

Safe operating area as a function of collector-emitter voltage

$I_D = f(V_{DS})$

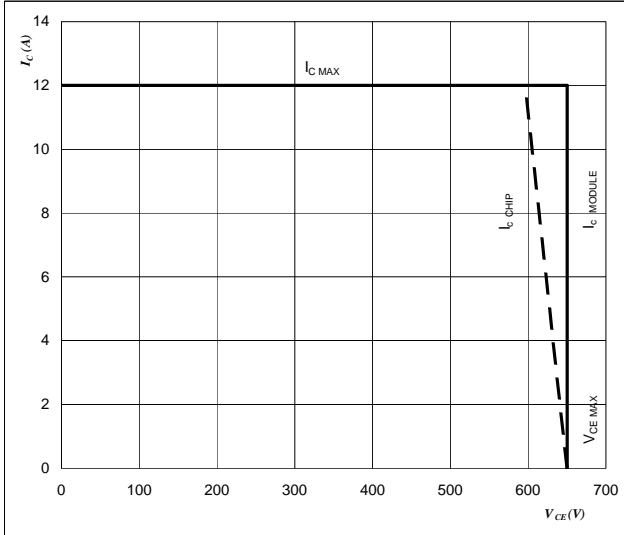


At  
 $D =$  single pulse  
 $T_s =$  80 °C  
 $U_{CC} =$  15 V  
 $T_j = T_{jmax}$  °C

figure 18. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  
 $T_j = T_{jmax-25}$  °C

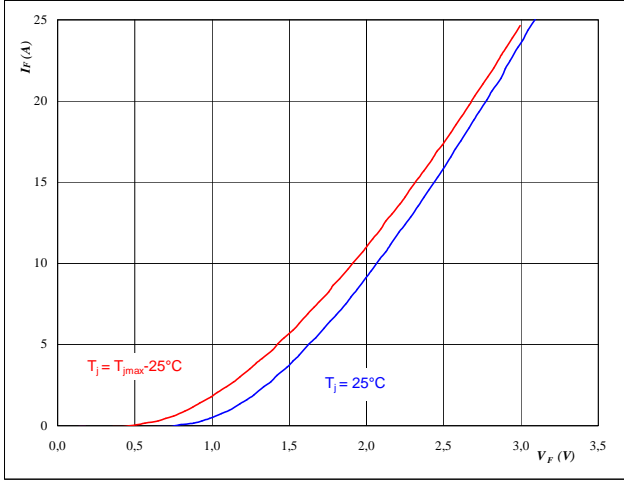


### PFC Inverse.Diode

**Figure 1** PFC Inverse.Diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

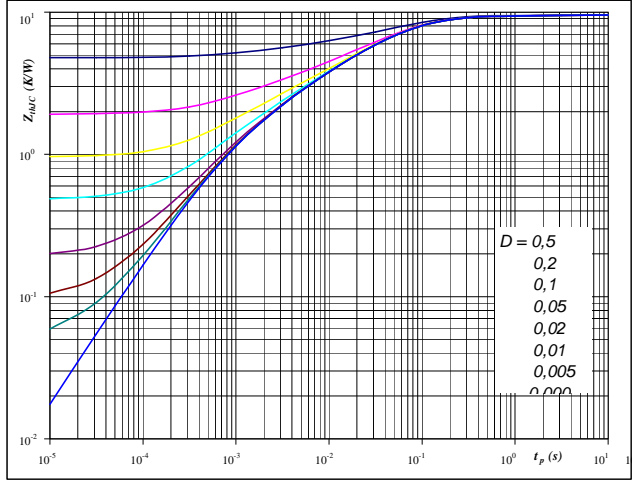


**At**  
 $t_p = 250 \mu s$

**Figure 2** PFC Inverse.Diode

Thyristor transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

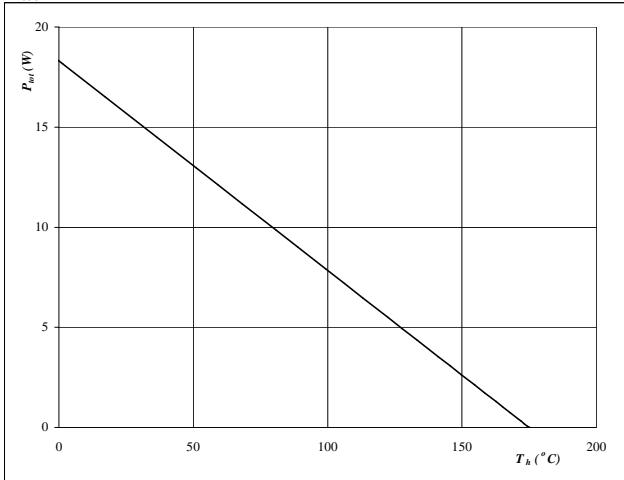


**At**  $D = t_p / T$   
Thermal grease  $R_{thJH} = 9,56 \text{ K/W}$

**Figure 3** PFC Inverse.Diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

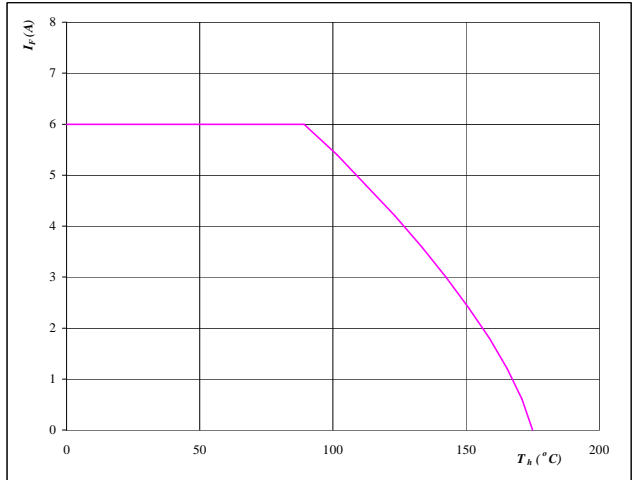


**At**  
 $T_j = 175 \text{ °C}$

**Figure 4** PFC Inverse.Diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



**At**  
 $T_j = 175 \text{ °C}$

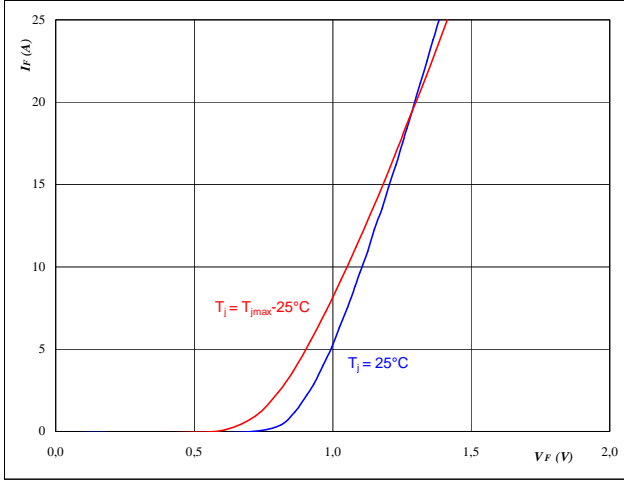


# Input Rectifier Diode

**figure 1. Rectifier Diode**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

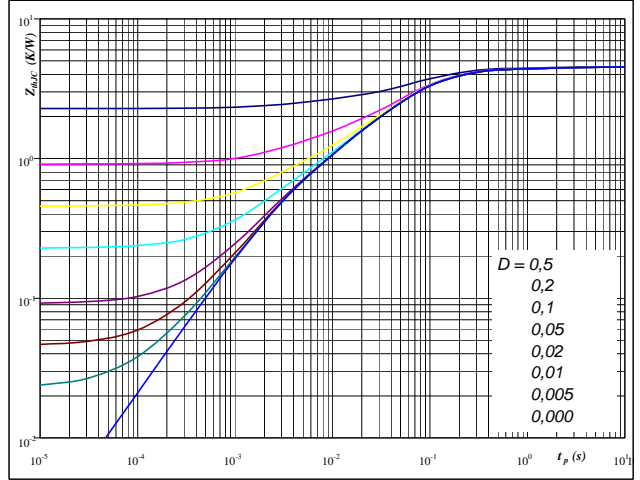


**At**  
 $t_p = 250 \mu s$

**figure 2. Rectifier Diode**

Diode transient thermal impedance as a function of pulse width

$$Z_{th(f-s)} = f(t_p)$$

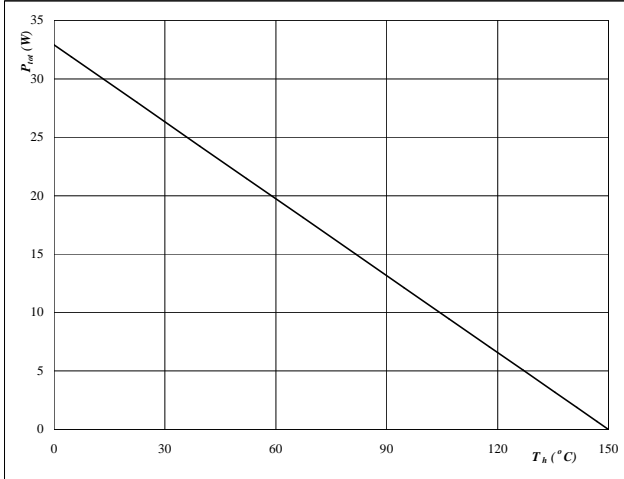


**At**  
 $D = t_p / T$   
 $R_{th(f-s)} = 4,56 \text{ K/W}$

**figure 3. Rectifier Diode**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

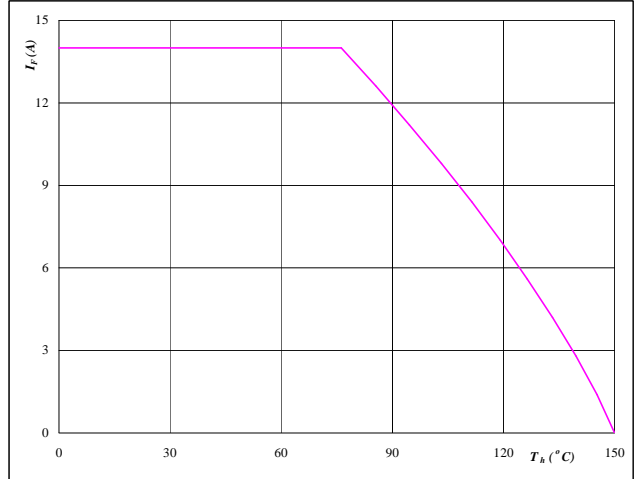


**At**  
 $T_j = 150 \text{ °C}$

**figure 4. Rectifier Diode**

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$



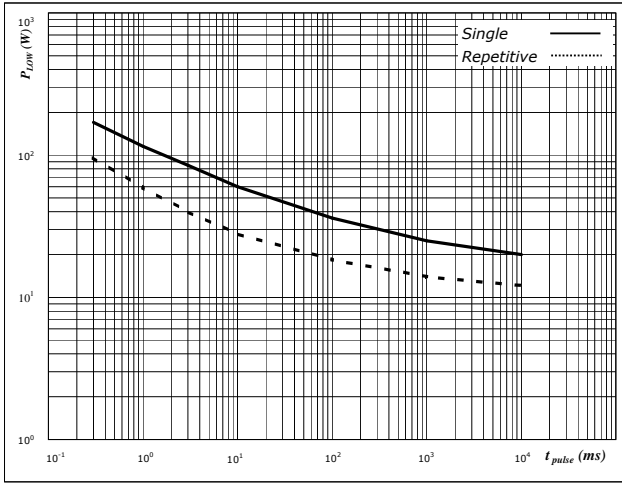
**At**  
 $T_j = 150 \text{ °C}$





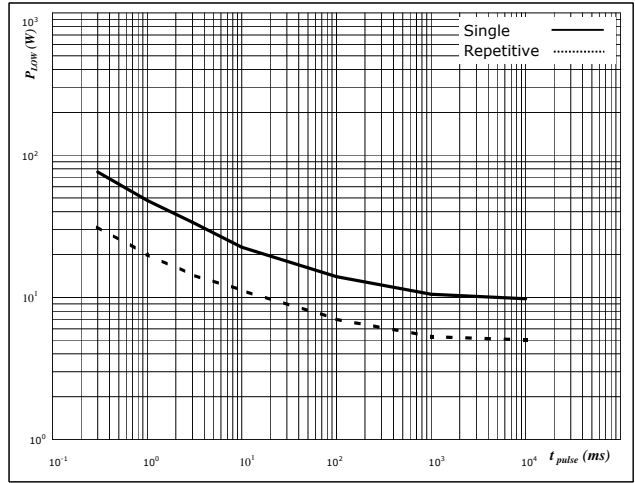
# Shunt

**figure 1. PFC Shunt**  
**Pulse Power R1**



—————  $dR/R_0 < 5\%$  after 1 pulse  
 .....  $dR/R_0 < 5\%$  after 10.000 cycles; duty cycle < 0,1%

**figure 2. DC Shunt**  
**Pulse Power R2**



—————  $dR/R_0 < 1\%$  after 1 pulse  
 .....  $dR/R_0 < 1\%$  after 10.000 cycles; duty cycle < 0,1%

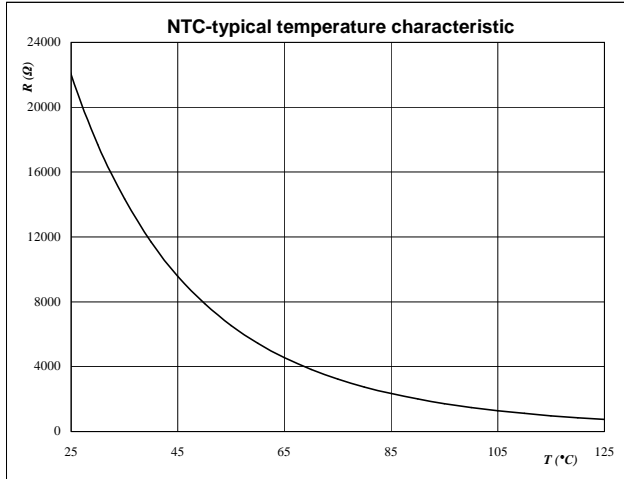


# Thermistor

**figure 1. Thermistor**

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$





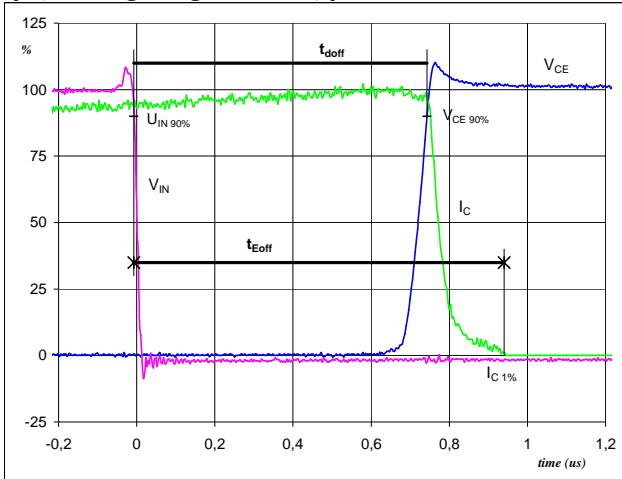
## Switching Definitions Output Inverter

General conditions

$T_j$	=	125 °C
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**figure 1. IGBT**

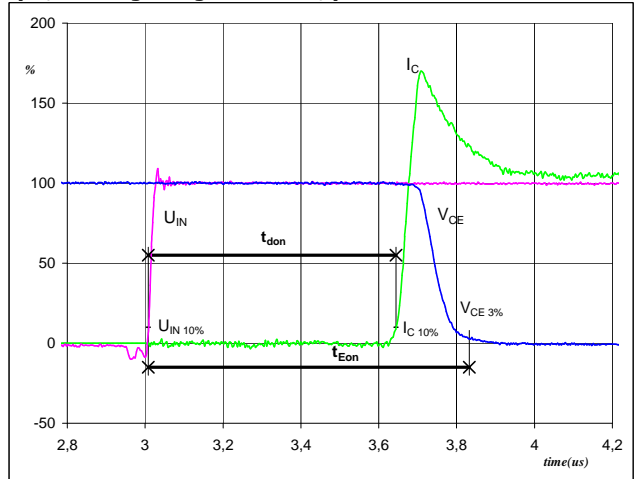
**Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$**   
 ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$U_{IN} (0\%) =$	0	V
$U_{IN} (100\%) =$	5	V
$V_C (100\%) =$	400	V
$I_C (100\%) =$	4	A
$t_{doff} =$	0,75	$\mu$ s
$t_{Eoff} =$	0,95	$\mu$ s

**figure 2. IGBT**

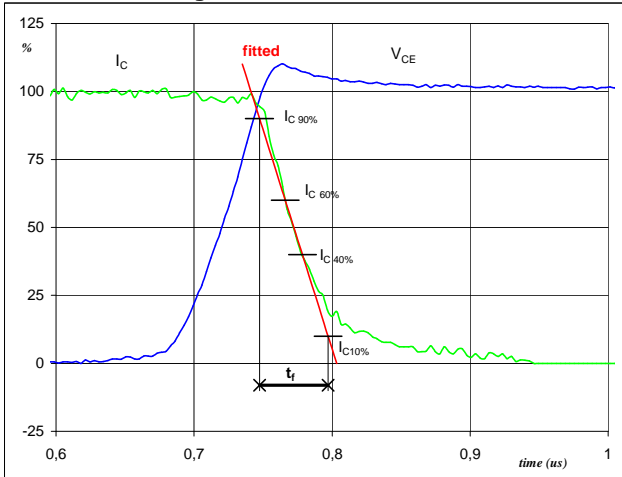
**Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$**   
 ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$U_{IN} (0\%) =$	0	V
$U_{IN} (100\%) =$	5	V
$V_C (100\%) =$	400	V
$I_C (100\%) =$	4	A
$t_{don} =$	0,64	$\mu$ s
$t_{Eon} =$	0,82	$\mu$ s

**figure 3. IGBT**

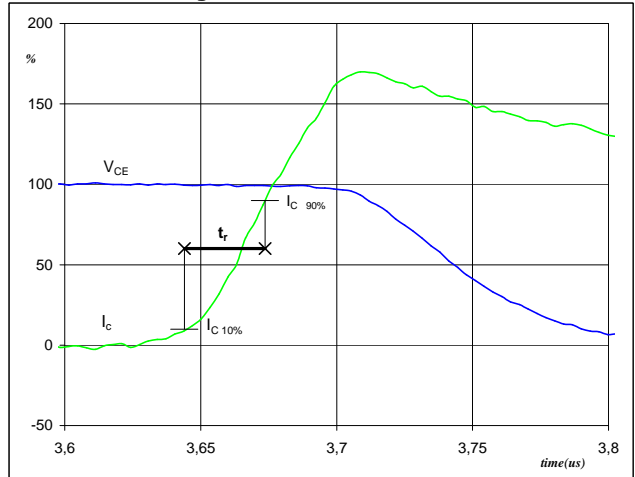
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C (100\%) =$	400	V
$I_C (100\%) =$	4	A
$t_f =$	0,05	$\mu$ s

**figure 4. IGBT**

**Turn-on Switching Waveforms & definition of  $t_r$**

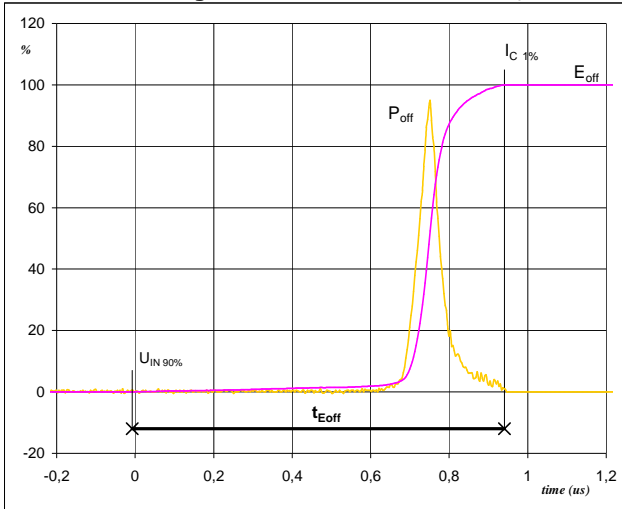


$V_C (100\%) =$	400	V
$I_C (100\%) =$	4	A
$t_r =$	0,03	$\mu$ s



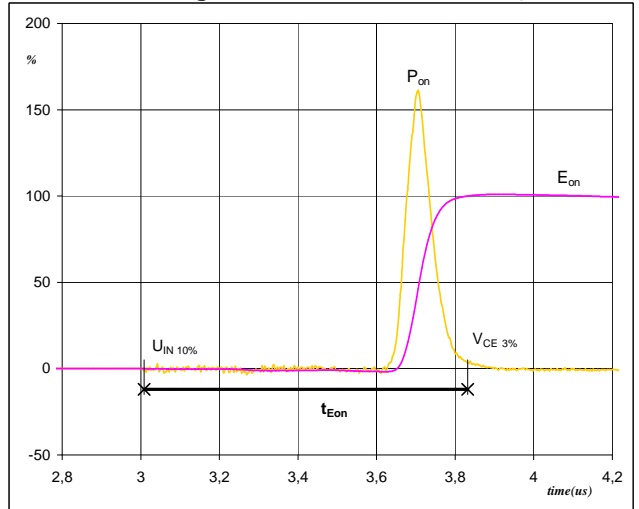
## Switching Definitions Output Inverter

**figure 5. IGBT**  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



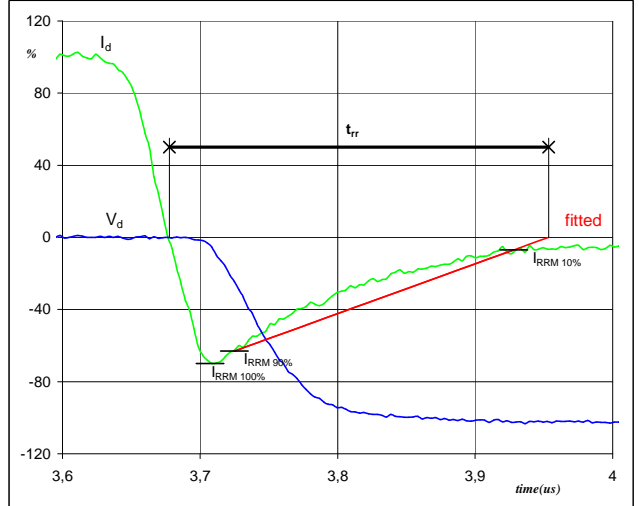
$P_{off} (100\%) = 1,61 \text{ kW}$   
 $E_{off} (100\%) = 0,12 \text{ mJ}$   
 $t_{Eoff} = 0,95 \text{ }\mu\text{s}$

**figure 6. IGBT**  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on} (100\%) = 1,61 \text{ kW}$   
 $E_{on} (100\%) = 0,20 \text{ mJ}$   
 $t_{Eon} = 0,82 \text{ }\mu\text{s}$

**figure 7. FWD**  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



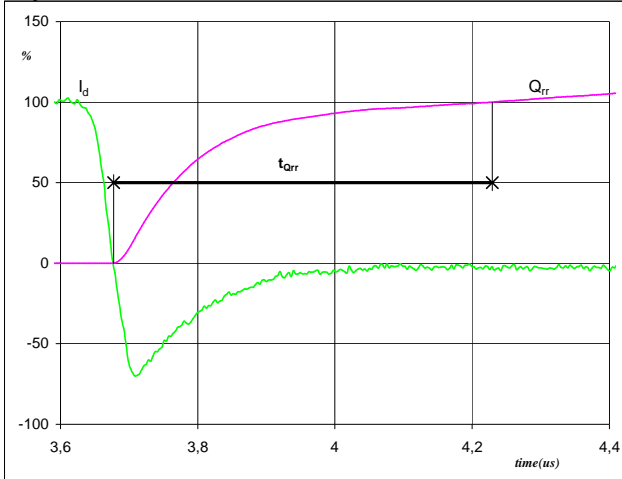
$V_d (100\%) = 400 \text{ V}$   
 $I_d (100\%) = 4 \text{ A}$   
 $I_{RRM} (100\%) = -3 \text{ A}$   
 $t_{rr} = 0,25 \text{ }\mu\text{s}$



### Switching Definitions Output Inverter

**figure 8.** FWD

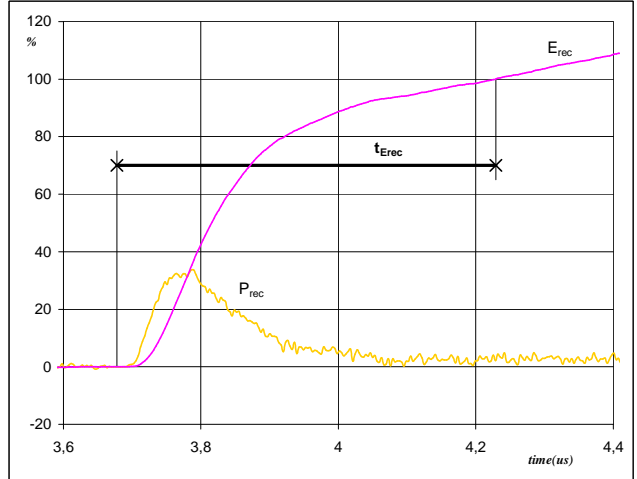
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	4	A
$Q_{rr}$ (100%) =	0,35	$\mu C$
$t_{Qrr}$ =	0,55	$\mu s$

**figure 9.** FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )

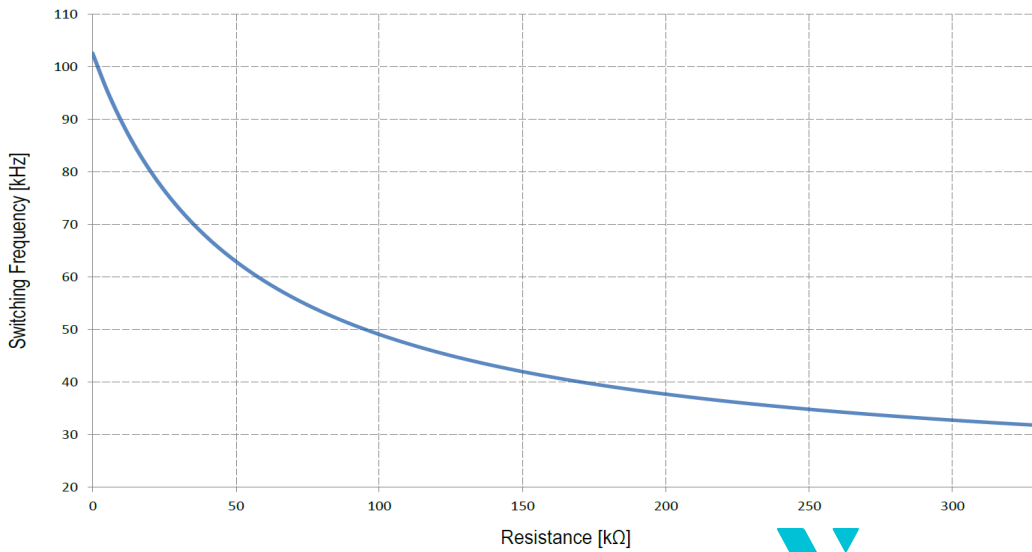


$P_{rec}$ (100%) =	1,61	kW
$E_{rec}$ (100%) =	0,09	mJ
$t_{Erec}$ =	0,55	$\mu s$

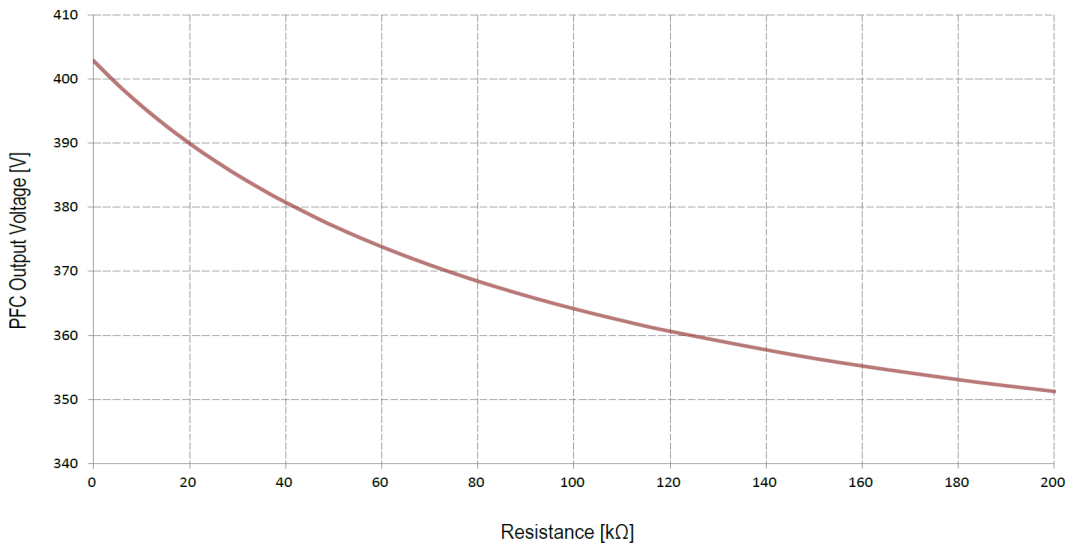


### Application data

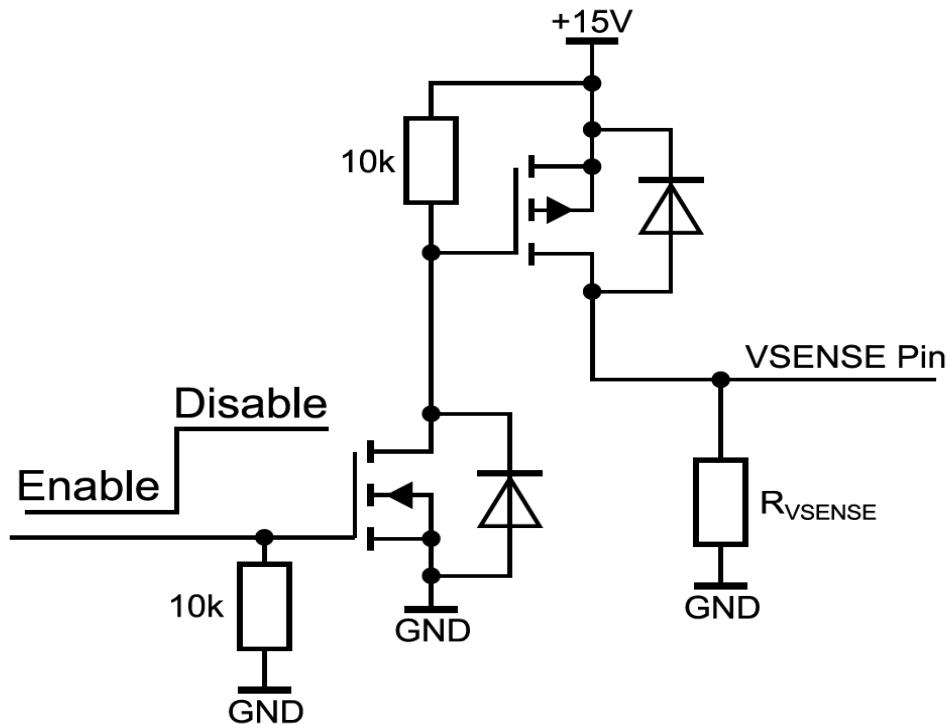
Static logic function table							
VCC	VBS	RCIN	ITRIP	ENABLE	FAULT	LO1,2,3	HO1,2,3
<V <sub>CCUV-</sub>	X	X	X	X	0	0	0
15V	<V <sub>BSUV-</sub>	X	0	3.3V	High imp	/LIN1,2,3	0
15V	15V	<3.2V↓	0	3.3V	0	0	0
15V	15V	X	> V <sub>IT,TH+</sub>	3.3V	0	0	0
15V	15V	> V <sub>RCIN,TH</sub>	0	3.3V	High imp	/LIN1,2,3	/HIN1,2,3
15V	15V	> V <sub>RCIN,TH</sub>	0	0	High imp	0	0



Resistance on f <sub>set</sub>	Switching Frequency
0Ω	102.6kHz
5.1kΩ	95.5kHz
10.0kΩ	89.7kHz
15.0kΩ	84.7kHz
20.0kΩ	80.3kHz
24.0kΩ	77.2kHz
30.0kΩ	73.2kHz
36.0kΩ	69.6kHz
39.0kΩ	68.0kHz
47.0kΩ	64.3kHz
51.0kΩ	62.6kHz
56.0kΩ	60.7kHz
62.0kΩ	58.6kHz
68.0kΩ	56.7kHz
75.0kΩ	54.7kHz
82.0kΩ	52.9kHz
91.0kΩ	50.9kHz
100.0kΩ	49.1kHz
110.0kΩ	47.3kHz
120.0kΩ	45.8kHz
150.0kΩ	42.0kHz
180.0kΩ	39.2kHz
200.0kΩ	37.7kHz



Resistance on V <sub>set</sub>	Output Voltage
0Ω	402.9V
5.1kΩ	399.2V
10.0kΩ	395.9V
15.0kΩ	392.8V
20.0kΩ	390.0V
24.0kΩ	387.9V
30.0kΩ	385.0V
36.0kΩ	382.4V
39.0kΩ	381.2V
47.0kΩ	378.1V
51.0kΩ	376.7V
56.0kΩ	375.1V
62.0kΩ	373.3V
68.0kΩ	371.5V
75.0kΩ	369.7V
82.0kΩ	368.0V
91.0kΩ	366.0V
100.0kΩ	364.2V
110.0kΩ	362.3V
120.0kΩ	360.6V
150.0kΩ	356.4V
180.0kΩ	353.1V
200.0kΩ	351.3V

**PFC enable circuit****Pin Descriptions**

Pin #	Pin Name	Pin Description
1	NTC2	Temperature sensor connector 1
2	NTC1	Temperature sensor connector 2
3	InvS +	Inverter sense resistor high-side
4	InvS -	Inverter sense resistor low-side
5	EN	Enable I/O functionality
6	¬Fault	Fault output, indicates over current or under voltage (negative)
7	¬LIN3	Signal input for low-side W phase
8	¬LIN2	Signal input for low-side V phase
9	¬LIN1	Signal input for low-side U phase
10	¬HIN3	Signal input for high-side W phase
11	¬HIN2	Signal input for high-side V phase
12	¬HIN1	Signal input for high-side U phase
13	V <sub>CC</sub>	Driver circuit supply voltage
14	GND2	Inverter ground
15	VSENSE	PFC Bulk voltage sense
16	FREQ	PFC Switching frequency adjust
17	AC1	Rectifier input
18	AC2	Rectifier input
19	DC1 + (coil)	Rectifier output DC +
20	PFC + (coil)	PFC coil connector
21	DC1 -	Rectifier output DC -
22	PFC -	PFC return
23	DC2 -	Inverter input DC -
24	DC2 +	Inverter input DC +
25	W	Output for W phase
26	V	Output for V phase
27	U	Output for U phase



**Ordering Code & Marking - Outline - Pinout**

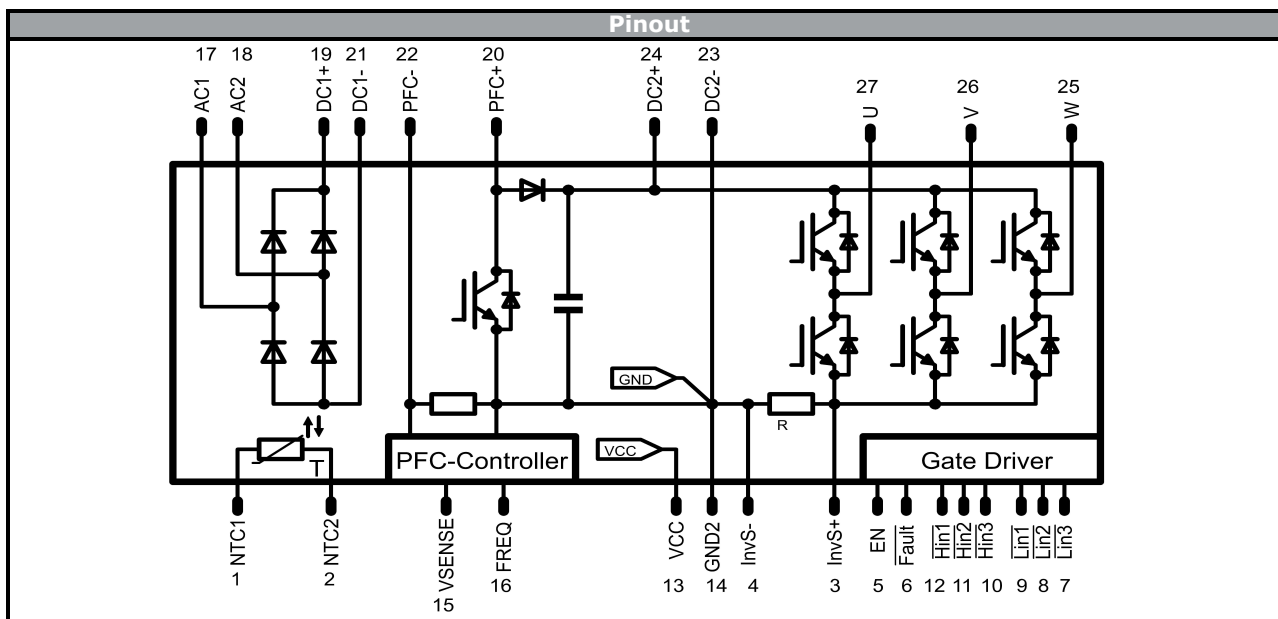
Ordering Code & Marking							
Version			Ordering Code				
without thermal paste, solder pins			20-1B06IPB004RC-P952A40				
with thermal paste, solder pins			20-1B06IPB004RC-P952A40-/3/				
without thermal paste, press fit pins			20-PB06IPB004RC-P952A40Y				
with thermal paste, press fit solder pins			20-PB06IPB004RC-P952A40Y-/3/				
NN-NNNNNNNNNNNNNN TTTTITVWVWVYY UL VIN LLLLL SSSS		Text	Name	Date code	UL & VIN	Lot	Serial
			NN-NNNNNNNNNNNNNN-TTTTITVW	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	TTTTITVW	LLLLL	Type&Ver	Lot number	Serial	Date code	
						WWYY	

Pin table [mm]				Outline
Pin	X	Y	Function	
1	45	0	NTC2	
2	42	0	NTC1	
3	39	0	Inv_S+	
4	36	0	Inv_S-	
5	33	0	EN	
6	30	0	FAULT	
7	27	0	LIN3	
8	24	0	LIN2	
9	21	0	LIN1	
10	18	0	HIN3	
11	15	0	HIN2	
12	12	0	HIN1	
13	9	0	VCC	
14	6	0	GND2	
15	3	0	VSENSE	
16	0	0	FREQ	
17	-0,2	26,4	AC1	
18	4,8	26,4	AC2	
19	9,8	26,4	DC1+	
20	14,8	26,4	PFC+	
21	19,8	26,4	DC1-	
22	22,5	26,4	PFC-	
23	25,2	26,4	DC2-	
24	30,2	26,4	DC2+	
25	35,2	26,4	W	
26	40,2	26,4	V	
27	45,2	26,4	U	





**Ordering Code & Marking - Outline - Pinout**




Identification					
ID	Component	Voltage	Current	Function	Comment
T1,T2,T3,T4,T5,T6	IGBT	600 V	4 A	Inverter Transistor	
T7	IGBT	650 V	15 A	PFC IGBT	
D12	FWD	650 V	15 A	PFC Diode	
D11	FWD	650 V	6 A	PFC inverse Diode	
R3	Resistor			PFC Shunt	
D7,D8,D9,D10	Rectifier	1600 V	12 A	Input Rectifier Diode	
R2	Resistor			DC - Shunt	
C1	Capacitor	500 V		DC link Capacitor	
T	Thermistor			Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ)	<b>100</b>	>SPQ Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow</i> 1B packages see vincotech.com website.

Package data
Package data for <i>flow</i> 1B packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
20-xB06IPB004RC-P952A40x-D4-14	08 Apr. 2017	Page number correction	8

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